

## WS3411 Active PFC Non-isolated Buck LED Driver

### Features

- High Power Factor Correction, Low Total Harmonic Distortion
- Dynamic Temperature Compensation
- 500V Power MOSFET Integrated
- No Auxiliary Winding For Supplying
- SOP8 Package, Up To 260mA Output Current
- Valley Switching, High efficiency, Low EMI
- Automatic Compensate the Inductance Variation
- Automatic Adapt to the Change of Output Voltage
- LED Short Circuit Protection
- Over Voltage Protection
- Over Temperature Protection
- Open Circuit Protection
- Few External Components

### General Description

The WS3411 is designed for active PFC non-isolated buck LED driver. It operates at valley switching mode with high efficiency, low EMI and High PF. The output current automatically adapt to the variation of the inductance and the output voltage. The truly constant current LED is realized.

The WS3411 integrates 500V power MOSFET, using SOP8 package, producing up to 260mA output current. It can achieve excellent constant current performance with very few external components.

The WS3411 offers rich protection functions, including over voltage protection, LED short circuit protection, cycle by cycle current limiting, dynamic temperature compensation, over temperature protection and soft start.

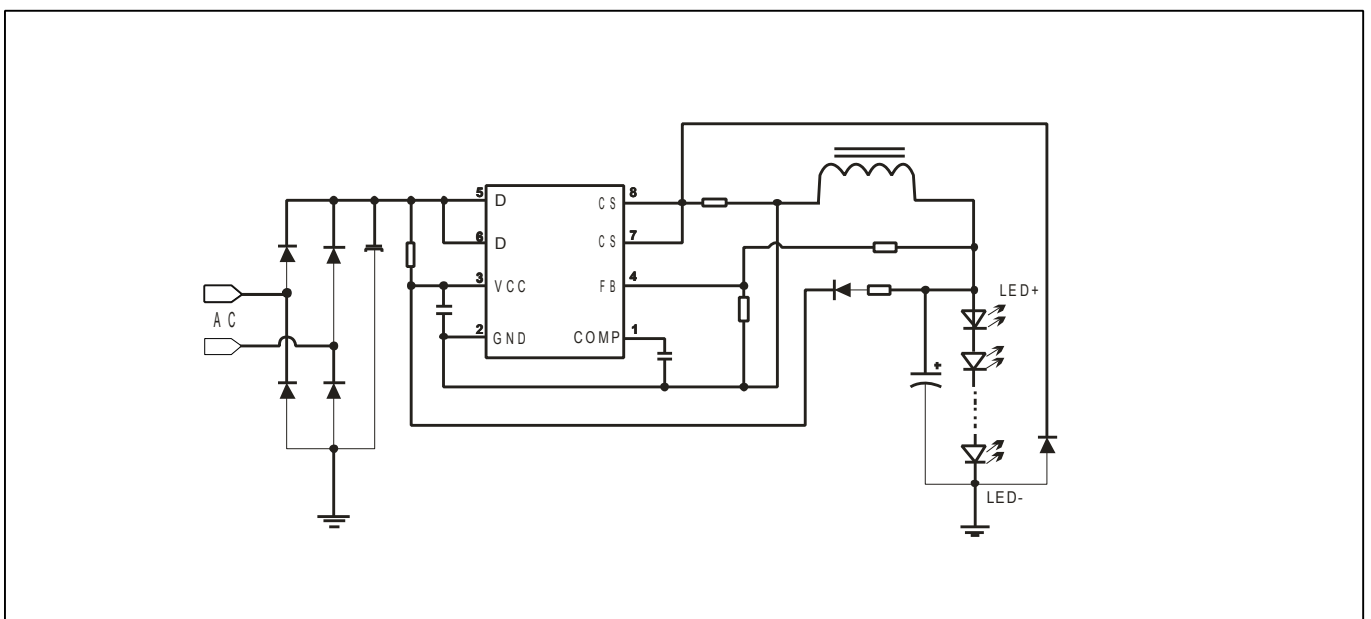
WS3411 consumes very low start current and operation current, driving LED efficiently under universal AC input(85VAC~265VAC).

WS3411 is available in SOP8 package.

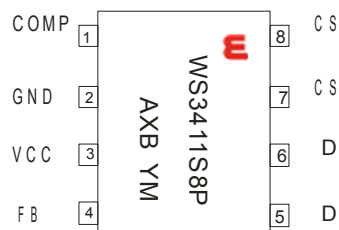
### Applications

- LED Driver Supply

### Typical Application Circuit

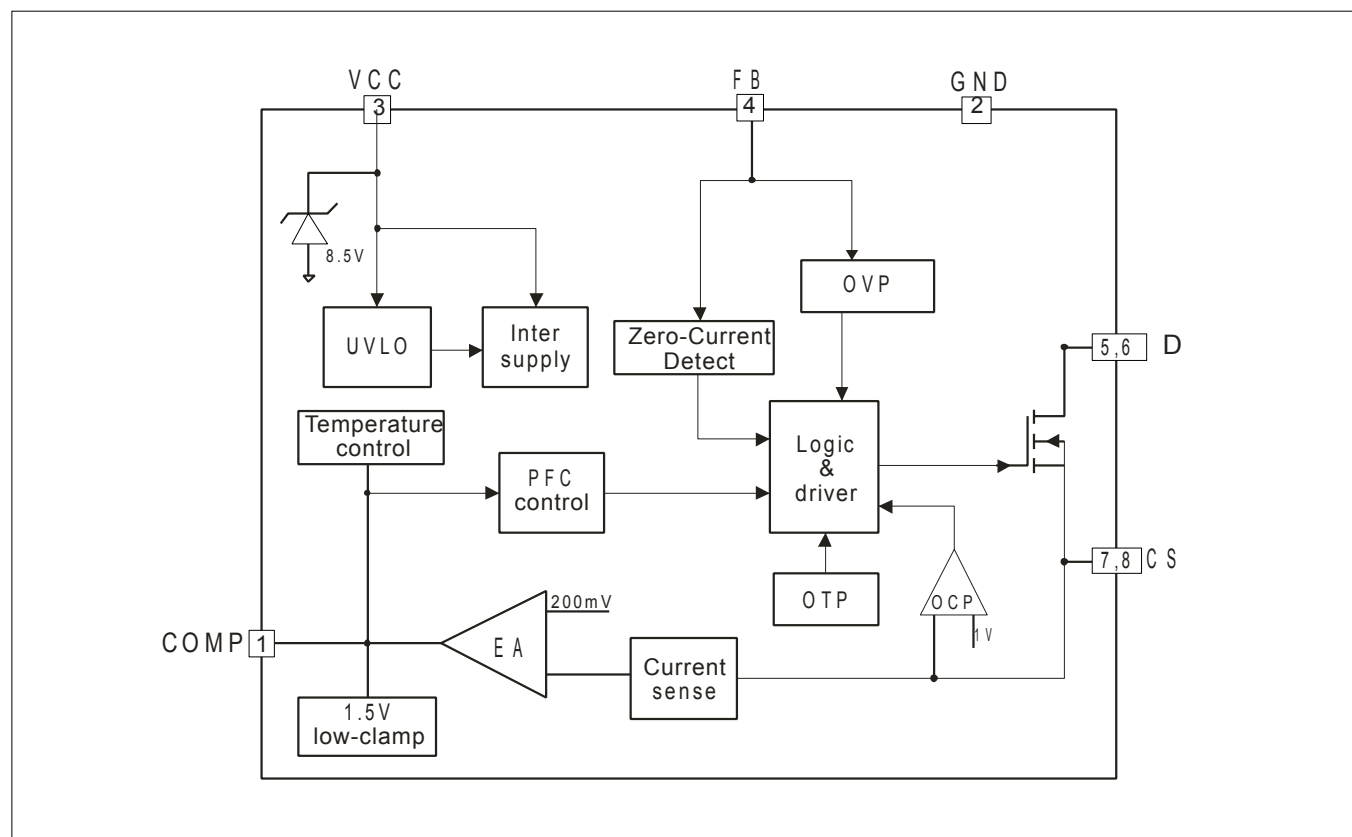


WS3411 is available in SOP-8 package.



YM: Year, Month

| Pin Name | Pin NO. | Description                                                     |
|----------|---------|-----------------------------------------------------------------|
| COMP     | 1       | Loop compensation, with a cap to GND.                           |
| GND      | 2       | Ground                                                          |
| VCC      | 3       | Power supply                                                    |
| FB       | 4       | Feedback signal input.                                          |
| D        | 5       | Internal HV power MOSFET drain                                  |
| D        | 6       | Internal HV power MOSFET drain                                  |
| CS       | 7       | Current sense input, connect to internal HV power MOSFET source |
| CS       | 8       | Current sense input, connect to internal HV power MOSFET source |



**Ordering Information**

| Package              | Part Number | Marking   |
|----------------------|-------------|-----------|
| 8-Pin SOP-8, Pb-free | WS3411S8P   | WS3411S8P |

**Recommended Operating Condition**

| symbol    | parameter          | value | units |
|-----------|--------------------|-------|-------|
| $I_{LED}$ | Output LED current | < 260 | mA    |

**Absolute Maximum Ratings**

| symbol     | parameter                           | Range    | Units |
|------------|-------------------------------------|----------|-------|
| $V_{DS}$   | Internal HV MOSFET drain voltage    | -0.3~500 | V     |
| VCC        | Power Supply                        | -0.3~8.5 | V     |
| $V_{CS}$   | Current sense pin input voltage     | -0.3~7   | V     |
| $V_{FB}$   | Feedback voltage input              | -0.3~7   | V     |
| $V_{COMP}$ | Loop Compensation Pin voltage       | -0.3~7   | V     |
| $P_{DMAX}$ | Power dissipation                   | 0.5      | W     |
| $T_J$      | Max. Operating junction temperature | 150      | °C    |
| $T_{STG}$  | Max./Min. Storage temperature range | -55~150  | °C    |

Note: Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. Under “recommended operating conditions” the device operation is assured, but some particular parameter may not be achieved.

**Electrical Characteristics** (Unless otherwise specified,  $T_A=25^{\circ}\text{C}$ ,  $V_{CC}=8\text{V}$ )

| Symbol                    | Parameter                                 | Conditions                          | Min | Typ | Max | Units              |
|---------------------------|-------------------------------------------|-------------------------------------|-----|-----|-----|--------------------|
| Supply Voltage Section    |                                           |                                     |     |     |     |                    |
| Vcc_clamp                 | VCC Clamping Voltage                      |                                     | 7.8 | 8.5 | 9.3 | V                  |
| Icc_clamp                 | VCC Clamping Current                      |                                     |     |     | 5   | mA                 |
| VCC_ST                    | VCC Start Up Voltage                      | VCC Rise                            |     | 7.5 |     | V                  |
| Vuvlo_HYS                 | VCC Under Voltage<br>Latch Out Hysteresis | VCC Falling                         |     | 1.5 |     | V                  |
| Ist                       | Start Up Current                          | $V_{CC} < V_{CC\_ST} - 0.5\text{V}$ |     | 70  | 100 | uA                 |
| Iop                       | Operation Current                         |                                     |     | 400 |     | uA                 |
| Current Sensor Section    |                                           |                                     |     |     |     |                    |
| Vocp                      | Current Sensor Voltage Threshold          |                                     |     | 1   |     | V                  |
| TLEB                      | Leading Edge Blanking                     |                                     |     | 350 |     | ns                 |
| TDELAY                    | Turn Off Delay Time                       |                                     |     | 200 |     | ns                 |
| Loop Compensation Section |                                           |                                     |     |     |     |                    |
| VREF                      | Internal Reference Voltage                |                                     | 194 | 200 | 206 | mV                 |
| VCL                       | Comp Low Clamp Voltage                    |                                     |     | 1.5 |     | V                  |
| VCH                       |                                           |                                     |     | 4   |     | V                  |
| Internal Driver Section   |                                           |                                     |     |     |     |                    |
| Toff_min                  | Min. Demagnetization Time                 |                                     |     | 3   |     | us                 |
| Ton_max                   | Max. On Time                              |                                     |     | 20  |     | us                 |
| Feedback input Section    |                                           |                                     |     |     |     |                    |
| VFB                       | OVP Threshold Voltage                     |                                     |     | 1.6 |     | V                  |
| VZCD                      | Zero Crossing Checking Threshold          |                                     |     | 0.2 |     | V                  |
| Internal HV MOSFET        |                                           |                                     |     |     |     |                    |
| RDSON                     | HV MOS ON Resistance                      |                                     |     |     | 10  | ohm                |
| VDS                       | Drain to Source voltage                   |                                     | 500 |     |     | V                  |
| Over Temperature Section  |                                           |                                     |     |     |     |                    |
| TSD                       | Thermal Shut Down Temperature             |                                     |     | 160 |     | $^{\circ}\text{C}$ |
| TSD_HYS                   | Thermal Shut Down Hysteresis              |                                     |     | 30  |     | $^{\circ}\text{C}$ |

## Function Description

The WS3411 is designed for active PFC non-isolated buck LED driver, which integrates 500V power MOSFET and using SOP8 package, producing up to 260mA output current. It operates under valley switching mode, automatically adapting to the variation of the inductance and the output voltage. It can achieve excellent constant current performance with very few external components.

### Start up

The start current is very low, Typ. 70uA(Max. 100uA). Under the design system of 85VAC, the startup resistor is:

$$R = \frac{85 * \sqrt{2}}{100} = 1.2M$$

### Chip Supply

After startup, the output voltage should supply the chip, rectifier diodes D6 need to use fast recovery diodes. Current limiting resistor R4 is calculated as:

$$R_4 = (1 - D) * \frac{V_{LED} - 9}{400\mu A}$$

Where, D is duty cycle, 400uA is the normal operation current of the chip, Vled is output load voltage. The consumption of R4 is:

$$P_{R4} = \frac{(V_{LED} - 9)^2}{R_4} * (1 - D)$$

For example:

Requirements: 180~260V input voltage, 36~80V output, 240mA output current.

The R4 design of above program should be met:

1. Supply Problem when Min. input AC voltage 180V and Min. output voltage 36V(which is the weakest power supply):

$$D = 36/180/1.414 = 0.141, R_4 = (1 - 0.141) * (36 - 9)/400\mu A = 58k$$

2. Power consumption problem of R4 when Max. input AC voltage 260V and Max. output voltage 80V(which is the strongest power supply):

$$D = 80/260/1.414 = 0.218$$

The power consumption of R4:

$$P = (80 - 9) * (80 - 9) / 58 * (1 - 0.218) = 68mW$$

### Sence Resistor

The WS3411 is designed for active PFC non-isolated buck LED driver. It operates under valley switching mode and can achieve high accuracy constant current performance with very few external components. The peak current of inductor is continuous detected. CS terminal is connected internal of the chip, and compared with the internal 200mV. Internal Amplifier's output COMP adjust the on-time, making the average value so CS equal to 200mV after the system is stable. In addition, a 1V cycle-by-cycle over current protection is set up inside CS pin.

LED output current:

$$I_{LED} = \frac{0.2V}{R_{CS}}$$

### FB Voltage Detection

FB voltage determines the working status of the system, when FB is greater than 1.6V(typ.), WS3411 will automatically considered as output over voltage protection. The system will enter extremely energy efficient hiccup mode. Output over voltage protection voltage as follows:

$$V_{OVP} = 1.6 * \frac{R_2 + R_3}{R_3}$$

R2, R3, please refer to the typical application diagram, in which R3=1k(no more than 2k). use 1.3 instead of constant 1.6 in the above formula in the design of system. Assuming Vovp=90V, we got R2=56k from the above formula, choosing 60k for R2 (larger as far as possible).

Because VFB2 is between 1.3 and 1.9, choose 1.9 to calculate the withstand voltage of C4,

$$V_{ovp} = 1.9 * (1 + 60)/1 = 116V$$

The withstand voltage of C4 should be larger than the above value, 200V capacitor could be used.

The WS3411 uses the patent source driver structure. The typical operation current is as low as 200uA, the auxiliary winding is not need. So the system design is simple and the cost is low.

WS3411 will automatic detect the output voltage when enters hiccup mode; and will re-enter the normal working state when the output voltage is lower than Vovp.

**Output Open(Short) protection**

Output open/short protection is integrated inside WS3411. Once output open/short circuit is detected, the system will automatic enter hiccup mode until the protection signal disappear.

**Over Temperature Automatic adjustment of output current**

WS3411 has over temperature regulating function, gradually reducing the output current when the power is over temperature, so as to control the output power and the temperature rise, keeping the power temperature in a setting value in order to improving the reliability of the system. The starting regulation temperature is 135°C.

**Input Filter Capacitor**

In order to obtain high PF value, the input capacitor can not be too large. 10-100nF is recommended.

**Power Factor Correction**

Active PFC control circuit is integrated in WS3411, which can get high PF value and low THD.

**PCB Design**

The following guidelines should be followed in WS3411 PCB layout:

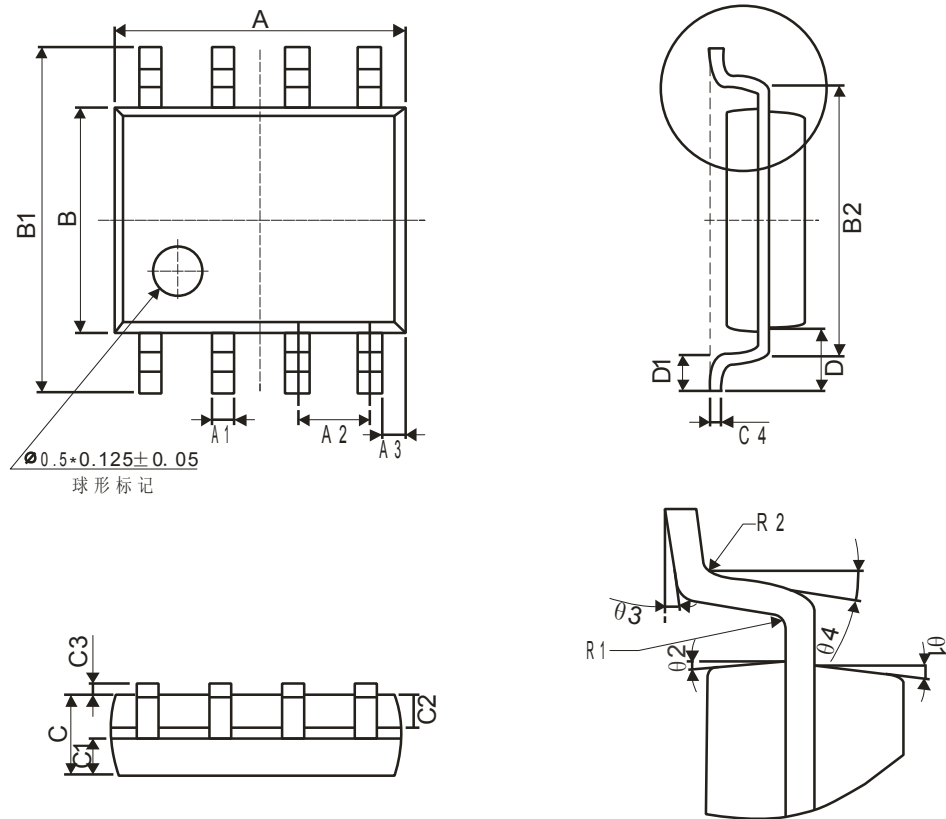
Bypass Capacitor: The bypass capacitor on VCC pin should be as close as possible to the VCC and GND pins.

Ground Path: The power ground path for current sense should be short, and the power ground path should be separated from small signal ground path before the negative node of the bulk capacitor.

The Area of Power Loop: The area of power loop should be as small as possible to reduce EMI radiation.

And the controller should be placed away from the heat generator, such as the power diode.

Package Information  
SOP-8 Package Outline Dimensions



| Winsemi |                           |       |                      |       |
|---------|---------------------------|-------|----------------------|-------|
| Symbol  | Dimensions in Millimeters |       | Dimensions in Inches |       |
|         | Min                       | Max   | Min                  | Max   |
| A       | 4.70                      | 5.10  | 0.185                | 0.201 |
| B       | 3.70                      | 4.10  | 0.146                | 0.161 |
| C       | 1.30                      | 1.50  | 0.051                | 0.059 |
| A1      | 0.35                      | 0.48  | 0.014                | 0.019 |
| A2      | 1.27TYP                   |       | 0.05TYP              |       |
| A3      | 0.345TYP                  |       | 0.014TYP             |       |
| B1      | 5.80                      | 6.20  | 0.228                | 0.244 |
| B2      | 5.00TYP                   |       | 0.197TYP             |       |
| C1      | 0.55                      | 0.70  | 0.022                | 0.028 |
| C2      | 0.55                      | 0.70  | 0.022                | 0.028 |
| C3      | 0.05                      | 0.225 | 0.002                | 0.009 |
| C4      | 0.203TYP                  |       | 0.008TYP             |       |
| D       | 1.05TYP                   |       | 0.041TYP             |       |
| D1      | 0.40                      | 0.80  | 0.016                | 0.031 |

**NOTE:**

- 1.We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.
- 2.Please do not exceed the absolute maximum ratings of the device when circuit designing.
- 3.Winsemi Microelectronics Co., Ltd reserved the right to make changes in this specification sheet and is subject to change without prior notice.

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